

800mA Fixed Output Voltage Linear Regulator

1 Features

- Rated Output Current: 0.8A
- Current Limit: 1.15A
- Output Noise: 0.003% (10Hz to 10kHz)
- PSRR: 70 dB (300mA, 120Hz)
- Output Voltage Accuracy: $\pm 1\%$
- On-chip Thermal Shutdown
- Maximum Quiescent Current: 5mA (Max)
- No External Components
- Compatible with Low ESR Ceramic Capacitor
- Operation Junction Temperature: -40 to 125°C
- RoHS Compliant and Halogen-Free

2 Applications

- USB devices
- TV and Monitors
- Add-on cards
- Mother Boards

3 Description

The GD30LD1117 is low dropout three-terminal regulators optimized for low voltage where transient response and minimum input voltage are critical. The device provides current-limit and thermal-shutdown features. Its circuit includes a trimmed bandgap reference to assure output voltage accuracy of within $\pm 1\%$. On-chip thermal shutdown provides protection against a combination of high current and ambient temperature that would create excessive junction temperature.

The GD30LD1117BSTR-I is available in fixed output voltage versions of 1.8V, 2.5V, 3.3V, 5.0V, and an adjustable output voltage version which can set the output voltage with two external resistors. The GD30LD1117BWTR is available in fixed output voltage version of 3.3V and 5.0V.

The GD30LD1117BSTR is available in the industry-standard SOT223 package, and GD30LD1117BWTR is SOT-89.

Device Information¹

PART NUMBER	PACKAGE	BODY SIZE (NOM)
GD30LD1117	SOT223	6.55 mm x 3.55 mm
	SOT89	4.50 mm x 2.45 mm

1. For all available packages, see the [Package Information](#) and [Ordering Information](#) at the end of data sheet.

Simplified Application Schematic

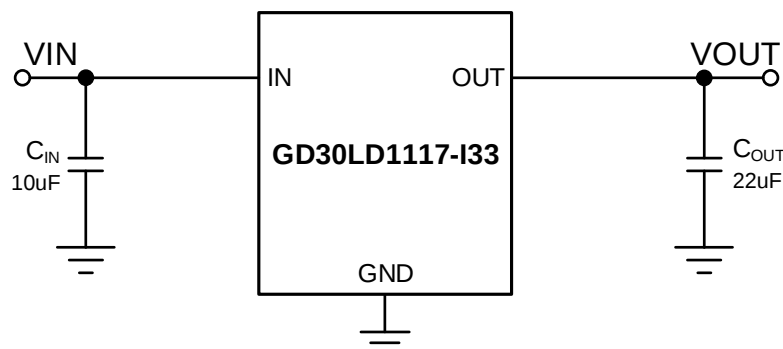
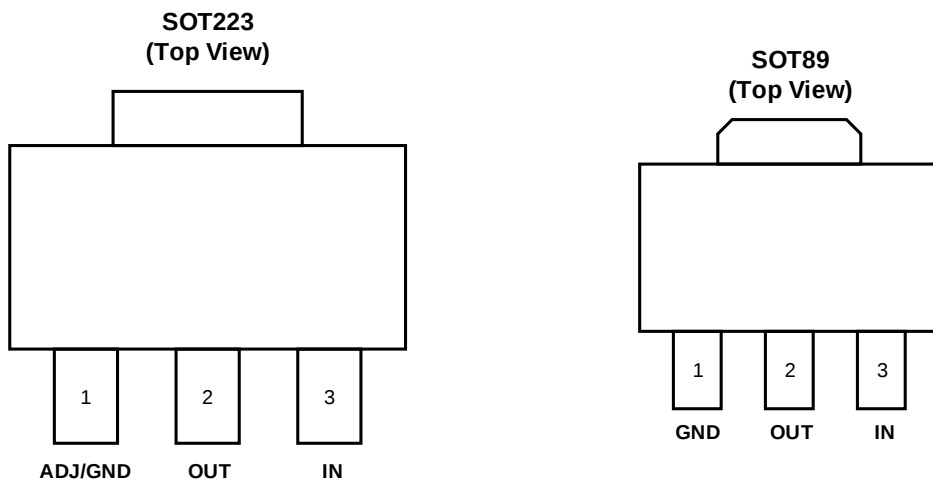


Table of Contents

1	Features	1
2	Applications	1
3	Description.....	1
	Table of Contents	2
4	Device Overview.....	3
4.1	Pinout and Pin Assignment	3
4.2	Pin Description	3
5	Parameter Information	4
5.1	Absolute Maximum Ratings.....	4
5.2	Recommended Operation Conditions	4
5.3	Electrical Sensitivity	4
5.4	Electrical Characteristics	4
5.5	Typical Characteristics	7
6	Functional Description	8
6.1	Block Diagram.....	8
7	Application Information	9
7.1	Typical Application Circuit	9
8	Layout Guidelines and Example.....	10
9	Package Information	11
9.1	Outline Dimensions	11
10	Ordering Information	15
11	Revision History	16

4 Device Overview

4.1 Pinout and Pin Assignment



4.2 Pin Description

NAME	PIN NUMBER		PIN TYPE ¹	FUNCTION
	SOT223	SOT89		
ADJ/GND	1	1	G	Adjust pin for adjustable output option. Ground pin for fixed output option.
OUT	2	2	P	Output pin.
IN	3	3	P	Power supply input pin.

1. I = Input, P = Power, G = Ground.

5 Parameter Information

5.1 Absolute Maximum Ratings

Exceeding the operating temperature range(unless otherwise noted)¹

SYMBOL	PARAMETER	MIN	MAX	UNIT
V _{IN}	Input Voltage		20	V
T _J	Operating Junction Temperature		150	°C
T _{LEAD}	Lead Temperature (Soldering, 10sec)		260	°C
T _{STG}	Storage Temperature Range	-65	150	°C

1. The maximum ratings are the limits to which the device can be subjected without permanently damaging the device. Note that the device is not guaranteed to operate properly at the maximum ratings. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

5.2 Recommended Operation Conditions

SYMBOL ¹	PARAMETER	MIN	TYP	MAX	UNIT
V _{IN}	Input supply voltage range			18	V
T _J	Operating junction temperature	-40		125	°C

1. The device is not guaranteed to function outside of its operating conditions.

5.3 Electrical Sensitivity

SYMBOL	CONDITIONS	VALUE	UNIT
V _{ESD(HBM)}	Human-body model (HBM), ANSI/ESDA/JEDEC JS-001-2017 ¹	±3000	V
V _{ESD(CDM)}	Charge-device model (CDM), ANSI/ESDA/JEDEC JS-002-2022 ²	±500	V

1. JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
2. JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

5.4 Electrical Characteristics

V_{IN} < 10V, I_O = 10mA, T_J = 25°C, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{OUT} = 1.8V						
V _{OUT}	Output voltage	25°C	1.782	1.8	1.818	V
		-20°C to 125°C	1.764	3.3	1.836	
V _{RLINE}	Line Regulation	1.5V ≤ V _{IN} - V _O ≤ 10V		0.5	6	mV
		1.5V ≤ V _{IN} - V _O ≤ 10V, -20°C to 125°C			10	
V _{RLOAD}	Load Regulation	10mA ≤ I _O ≤ 0.8A		10	30	mV
I _Q	Quiescent Current			3.5	5	mA
I _{LIM}	Current limit		0.85	1.15		A
PSRR	Ripple Rejection	F = 120Hz, I _O = 300mA, V _{IN} - V _O = 3V, C _{OUT} = 22μF		70		dB

Electrical Characteristics (Continued)

$V_{IN} < 10V$, $I_O = 10mA$, $T_J = 25^{\circ}C$, unless otherwise noted.

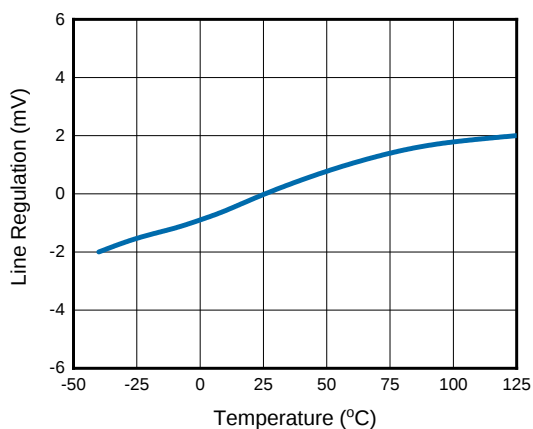
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Hysteresis			16		$^{\circ}C$
$V_{OUT} = 2.5V$						
V_{OUT}	Output voltage	$25^{\circ}C$	2.475	2.5	2.525	V
		$-20^{\circ}C$ to $125^{\circ}C$	2.455	2.5	2.545	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	5	mA
I_{LIM}	Current limit		0.85	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Hysteresis			16		$^{\circ}C$
$V_{OUT} = 3.3V$						
V_{OUT}	Output voltage	$25^{\circ}C$	3.267	3.3	3.333	V
		$-20^{\circ}C$ to $125^{\circ}C$	3.235	3.3	3.365	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	5	mA
I_{LIM}	Current limit		0.85	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Protection Hysteresis			16		$^{\circ}C$

Electrical Characteristics (Continued)

 $V_{IN} < 10V$, $I_O = 10mA$, $T_J = 25^{\circ}C$, unless otherwise noted.

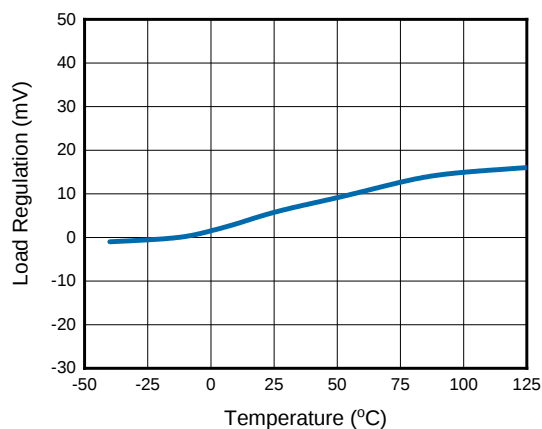
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
$V_{OUT} = 5V$						
V_{OUT}	Output voltage	$25^{\circ}C$	4.950	5.0	5.050	V
		$-20^{\circ}C$ to $125^{\circ}C$	4.900	5.0	5.10	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$		0.5	6	mV
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			10	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		10	30	mV
I_Q	Quiescent Current			3.5	6	mA
I_{LIM}	Current limit		0.9	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Protection Hysteresis			16		$^{\circ}C$
$V_{OUT} ADJ$						
V_{REF}	Reference voltage	$1.5V \leq V_{IN} - V_O \leq 10V$, $25^{\circ}C$	1.238	1.250	1.262	V
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$	1.225	1.250	1.270	
V_{RLINE}	Line Regulation	$1.5V \leq V_{IN} - V_O \leq 10V$, $25^{\circ}C$		0.001	0.1	%
		$1.5V \leq V_{IN} - V_O \leq 10V$, $-20^{\circ}C$ to $125^{\circ}C$			0.2	
V_{RLOAD}	Load Regulation	$10mA \leq I_O \leq 0.8A$		0.4	1	mV
I_{ADJ}	Adjust Pin Current	$1.5V \leq V_{IN} - V_O \leq 10V$		60	120	μA
ΔI_{ADJ}	Adjust Pin Current Change			0.2	0.5	μA
I_{MIN}	Minimum Load Current	$1.5V \leq V_{IN} - V_O \leq 10V$		1.7	5	mA
I_{LIM}	Current limit		0.9	1.15		A
PSRR	Ripple Rejection	$F = 120Hz, I_O = 300mA$, $V_{IN} - V_O = 3V, C_{OUT} = 22\mu F$		70		dB
V_{DROP}	Dropout Voltage	$\Delta V_O = 1\%$, $I_O = 0.8A$		1.2	1.3	V
No	Output Noise Voltage	$10Hz \leq f \leq 100kHz$		0.003		%
T_{OTP}	Over temperature Protection			160		$^{\circ}C$
T_{OTP_HYS}	Over temperature Protection Hysteresis			16		$^{\circ}C$

5.5 Typical Characteristics



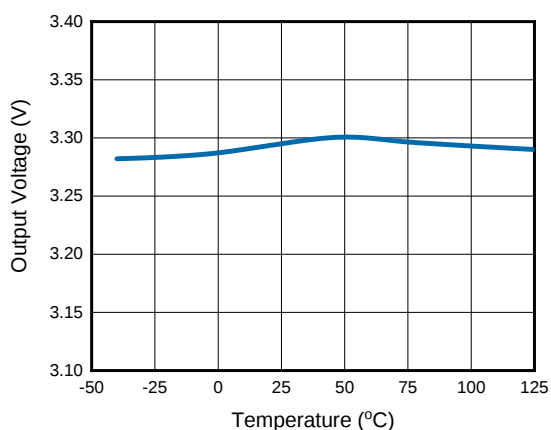
$V_{IN} = 4.8V$ to $13.3V$, $V_{OUT} = 3.3V$, $I_{OUT} = 10mA$

Figure 1. Line Regulation vs. Temperature



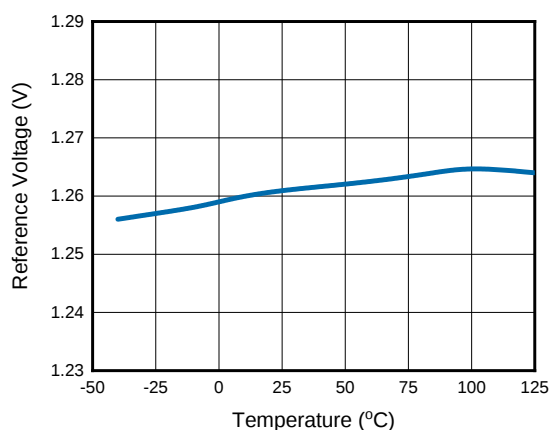
$V_{IN} = 5V$, $V_{OUT} = 3.3V$, $I_{OUT} = 10mA$ to $0.8A$

Figure 2. Load Regulation vs. Temperature



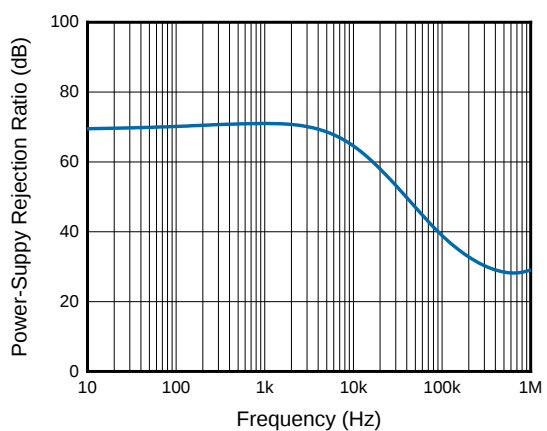
$V_{IN} = 5V$, $V_{OUT} = 3.3V$, $I_{OUT} = 10mA$

Figure 3. Output Voltage vs. Temperature



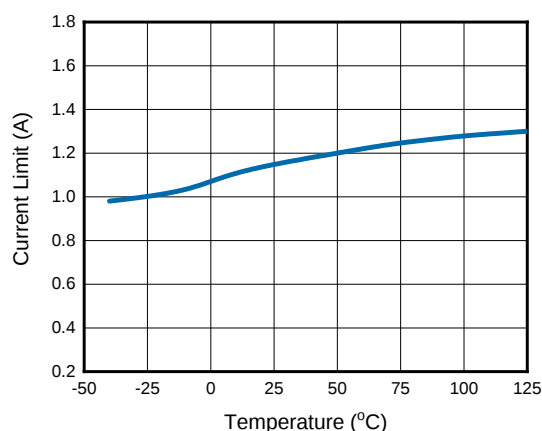
$V_{IN} = 5V$, $V_{OUT} = ADJ$, $I_{OUT} = 10mA$

Figure 4. Reference Voltage vs. Temperature



$V_{IN} = V_{OUT} + 2V_{DC}$, $V_{OUT} = ADJ$, $I_{OUT} = 100mA$

Figure 5. PSRR vs. Frequency



$V_{IN} = V_{OUT} + 1.5V$, $V_{OUT} = ADJ$

Figure 6. Current Limit vs. Temperature

6 Functional Description

6.1 Block Diagram

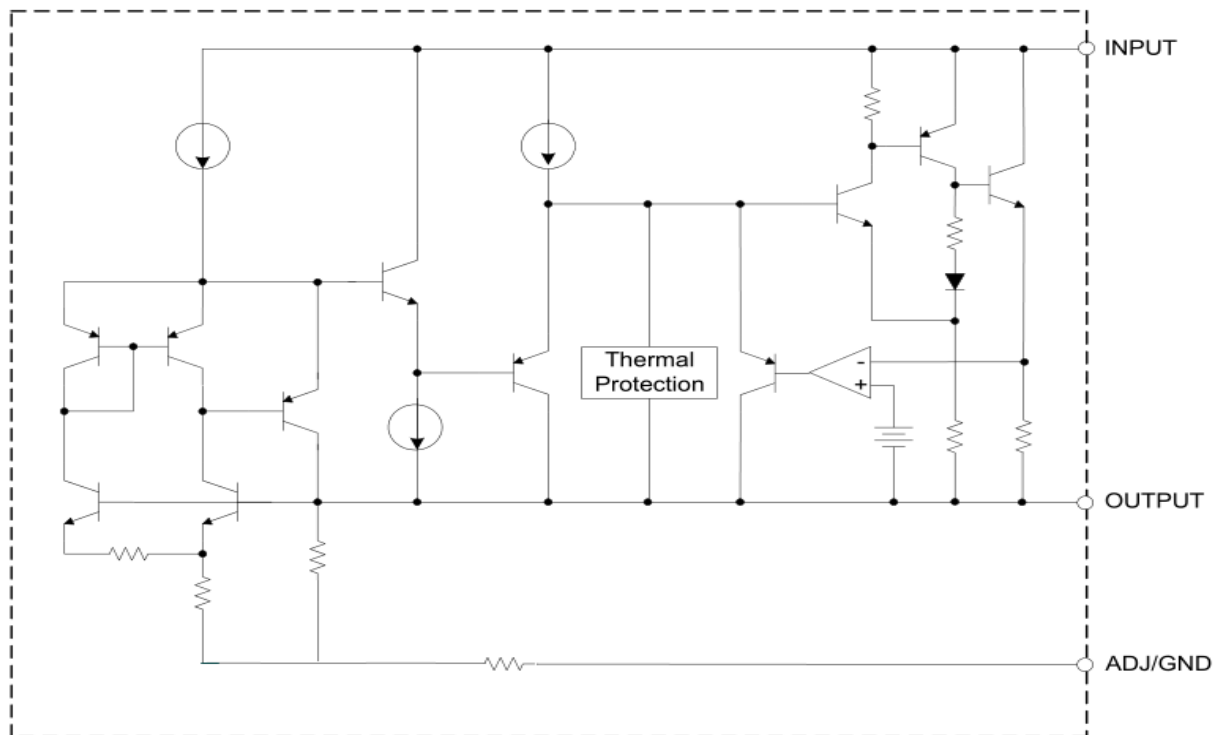


Figure 7. GD30LD1117 Functional Block Diagram

7 Application Information

7.1 Typical Application Circuit

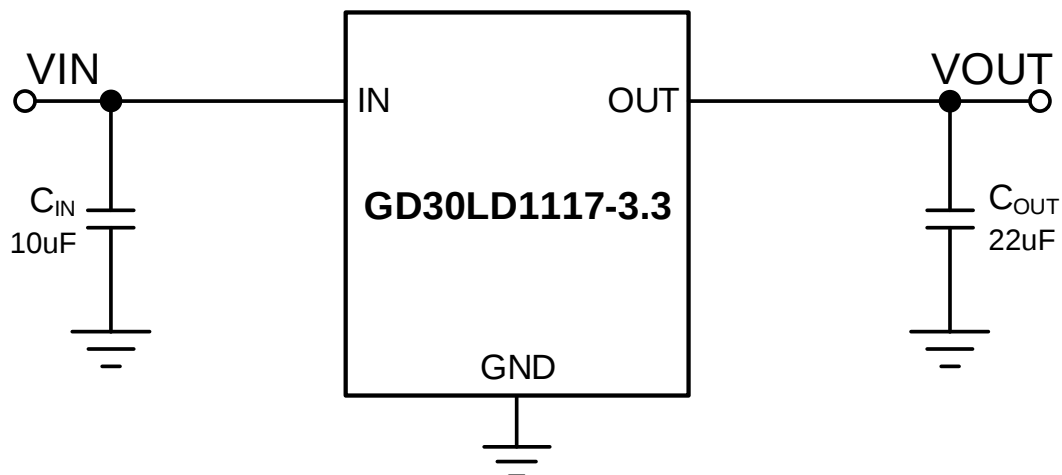
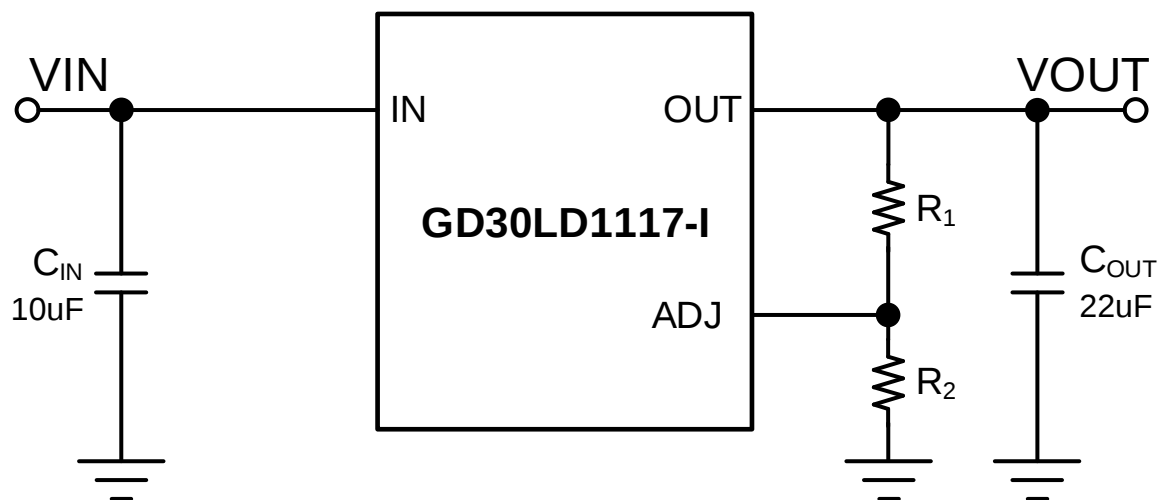


Figure 8. Reference Design Schematic of Fixed-Output



$$V_{OUT} = V_{REF} \times (1 + R_2/R_1) + I_{ADJ} \times R_2$$

Figure 9. Reference Design Schematic of Adjust-Output

8 Layout Guidelines and Example

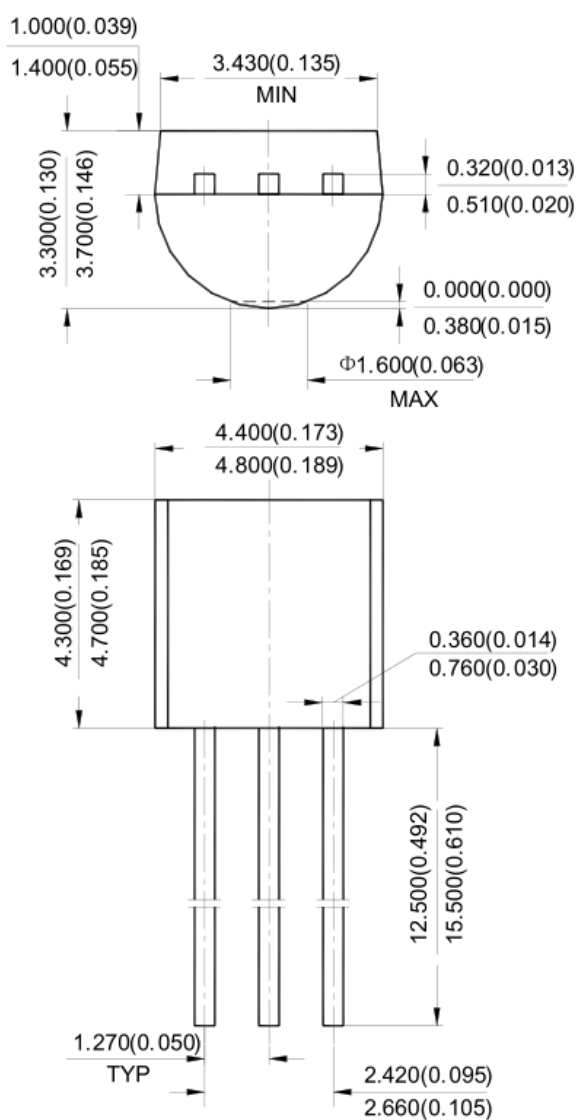
By placing input and output capacitors on the same side of the PCB as the LDO, and placing them as close as is practical to the package can achieve the best performance. The ground connections for input and output capacitors must be back to the GD30LD1117 ground pin using as wide and as short of a copper trace as is practical.

Connections using long trace lengths, narrow trace widths, and/or connections through via must be avoided. These add parasitic inductances and resistance that results in worse performance especially during transient conditions.

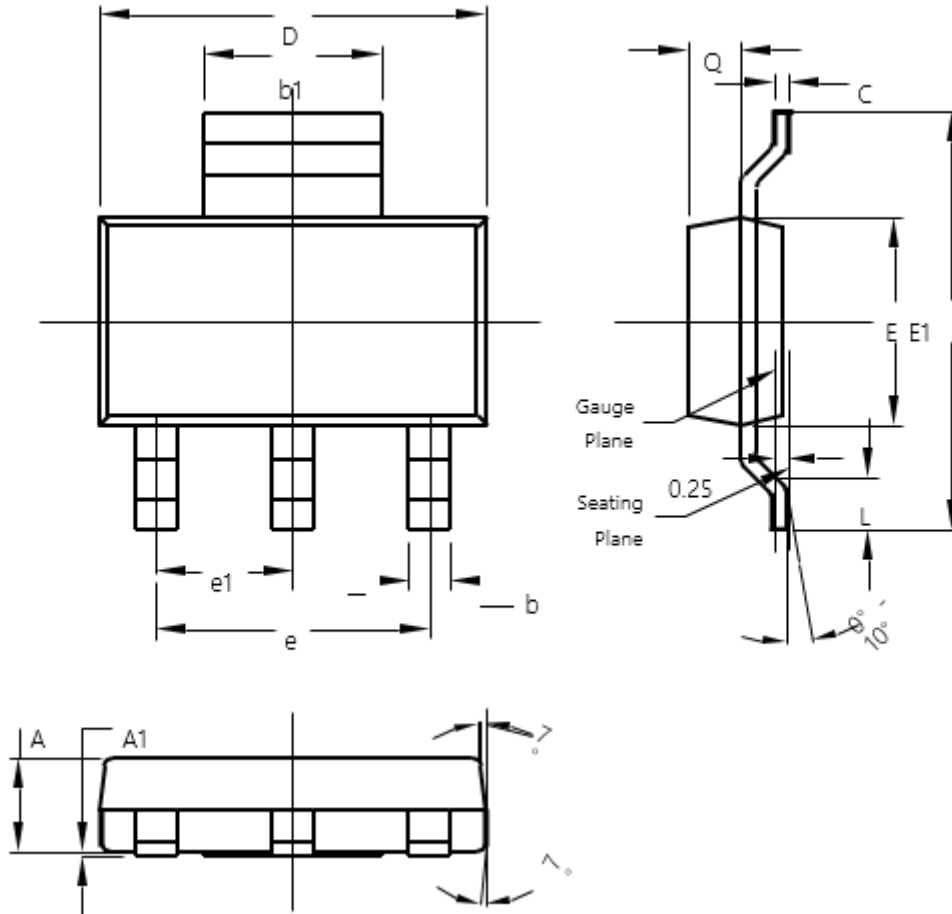
9 Package Information

9.1 Outline Dimensions

TO-92(Bulk Packing)



TO-92(Ammo Packing)



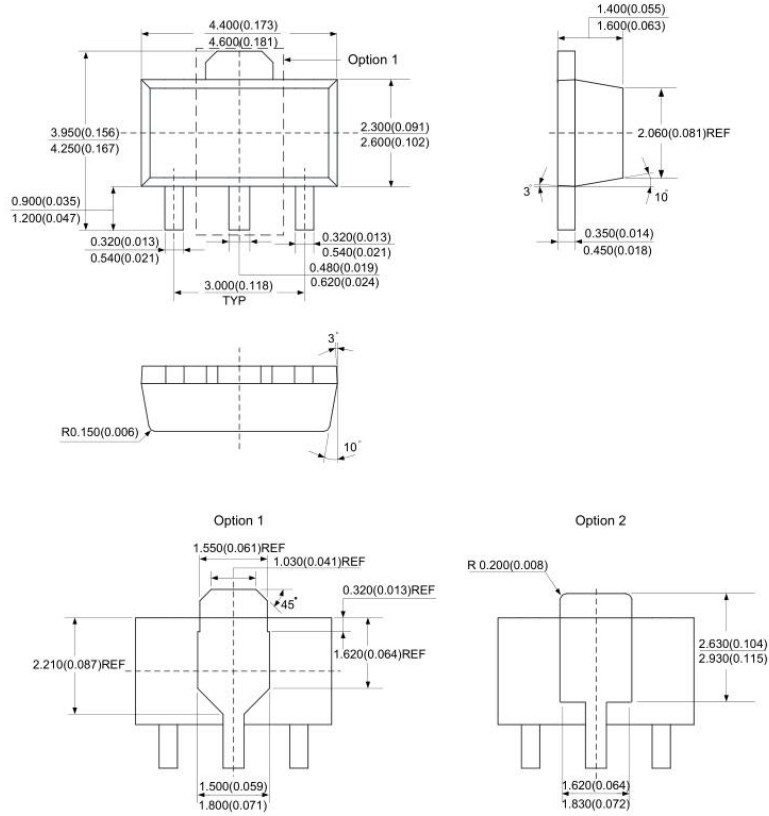
NOTES:

1. All dimensions are in millimeters.
2. Package dimensions does not include mold flash, protrusions, or gate burrs.
3. Refer to the [Table 1 SOT223 dimensions\(mm\)](#).

Table 1. SOT223 dimensions(mm)

SYMBOL	MIN	NOM	MAX
A	1.55	1.60	1.65
A1	0.01	0.05	0.15
b	0.60	0.70	0.80
b1	2.90	3.10	3.00
c	0.20	0.25	0.30
D	6.45	6.50	6.55
E	3.45	3.50	3.55
E1	6.90	7.00	7.10
e		4.60	
e1		2.30	
L	0.85	0.95	1.05
Q	0.84	0.89	0.94

SOT-89



NOTES(Continued):

1. All dimensions are in millimeters.
2. Package dimensions does not include mold flash, protrusions, or gate burrs.

10 Ordering Information

Ordering Code	Package Type	ECO Plan	Packing Type	MOQ	OP Temp(°C)
GD30LD1117BSTR-I	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I18	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I25	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I33	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BSTR-I50	SOT223	Green	Tape & Reel	4000	-40°C to +125°C
GD30LD1117BWTR-I33	SOT89	Green	Tape & Reel	1000	-40°C to +125°C
GD30LD1117BWTR-I50	SOT89	Green	Tape & Reel	1000	-40°C to +125°C

11 Revision History

REVISION NUMBER	DESCRIPTION	DATE
1.0	Initial release and device details	2024

Important Notice

This document is the property of GigaDevice Semiconductor Inc. and its subsidiaries (the "Company"). This document, including any product of the Company described in this document (the "Product"), is owned by the Company according to the laws of the People's Republic of China and other applicable laws. The Company reserves all rights under such laws and no Intellectual Property Rights are transferred (either wholly or partially) or licensed by the Company (either expressly or impliedly) herein. The names and brands of third party referred thereto (if any) are the property of their respective owner and referred to for identification purposes only.

The Company makes no representations or warranties of any kind, express or implied, with regard to the merchantability and the fitness for a particular purpose of the Product, nor does the Company assume any liability arising out of the application or use of any Product described in this document. Any information provided in this document is provided only for reference purposes. It is the sole responsibility of the user of this document to determine whether the Product is suitable and fit for its applications and products planned, and properly design, program, and test the functionality and safety of its applications and products planned using the Product. Unless otherwise expressly specified in the datasheet of the Product, the Product is designed, developed, and/or manufactured for ordinary business, industrial, personal, and/or household applications only, and the Product is not designed or intended for use in (i) safety critical applications such as weapons systems, nuclear facilities, atomic energy controller, combustion controller, aeronautic or aerospace applications, traffic signal instruments, pollution control or hazardous substance management; (ii) life-support systems, other medical equipment or systems (including life support equipment and surgical implants); (iii) automotive applications or environments, including but not limited to applications for active and passive safety of automobiles (regardless of front market or aftermarket), for example, EPS, braking, ADAS (camera/fusion), EMS, TCU, BMS, BSG, TPMS, Airbag, Suspension, DMS, ICMS, Domain, ESC, DCDC, e-clutch, advanced-lighting, etc.. Automobile herein means a vehicle propelled by a self-contained motor, engine or the like, such as, without limitation, cars, trucks, motorcycles, electric cars, and other transportation devices; and/or (iv) other uses where the failure of the device or the Product can reasonably be expected to result in personal injury, death, or severe property or environmental damage (collectively "Unintended Uses"). Customers shall take any and all actions to ensure the Product meets the applicable laws and regulations. The Company is not liable for, in whole or in part, and customers shall hereby release the Company as well as its suppliers and/or distributors from, any claim, damage, or other liability arising from or related to all Unintended Uses of the Product. Customers shall indemnify and hold the Company, and its officers, employees, subsidiaries, affiliates as well as its suppliers and/or distributors harmless from and against all claims, costs, damages, and other liabilities, including claims for personal injury or death, arising from or related to any Unintended Uses of the Product.

Information in this document is provided solely in connection with the Product. The Company reserves the right to make changes, corrections, modifications or improvements to this document and the Product described herein at any time without notice. The Company shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2024 GigaDevice – All rights reserved